
HD74HCT563/HD74HCT573

Octal Transparent Latches (with 3-state outputs)

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Description

When the latch enable (LE) input is high, the Q outputs of HD74HCT563 will follow the inversion of the D inputs and the Q outputs of HD74HCT573 will follow the D inputs.

When the latch enable goes low, data at the D inputs will be retained at the outputs until latch enabled returns high again. When a high logic level is applied to the output control input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

Features

- LSTTL Output Logic Level Compatibility as well as CMOS Output Compatibility
- High Speed Operation: t_{pd} (D to Q, \bar{Q}) = 13 ns typ ($C_L = 50$ pF)
- High Output Current: Fanout of 15 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 4.5$ to 5.5 V
- Low Input Current: 1 μ A max
- Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max ($T_a = 25^\circ\text{C}$)

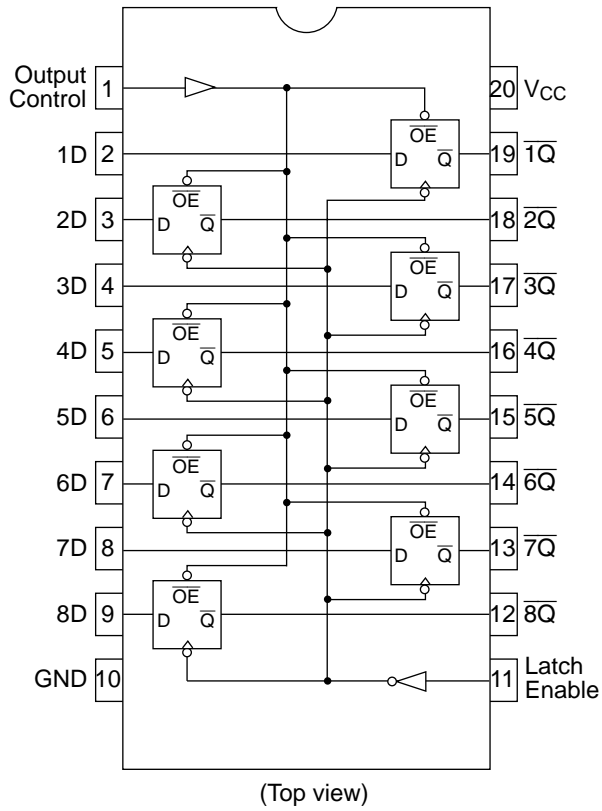
Function Table

| Output Control | Latch Enable | Data | Outputs | |
|----------------|--------------|------|-------------|------------|
| | | | HD74HCT563 | HD74HCT573 |
| L | H | H | L | H |
| L | H | L | H | L |
| L | L | X | \bar{Q}_0 | Q_0 |
| H | X | X | Z | Z |

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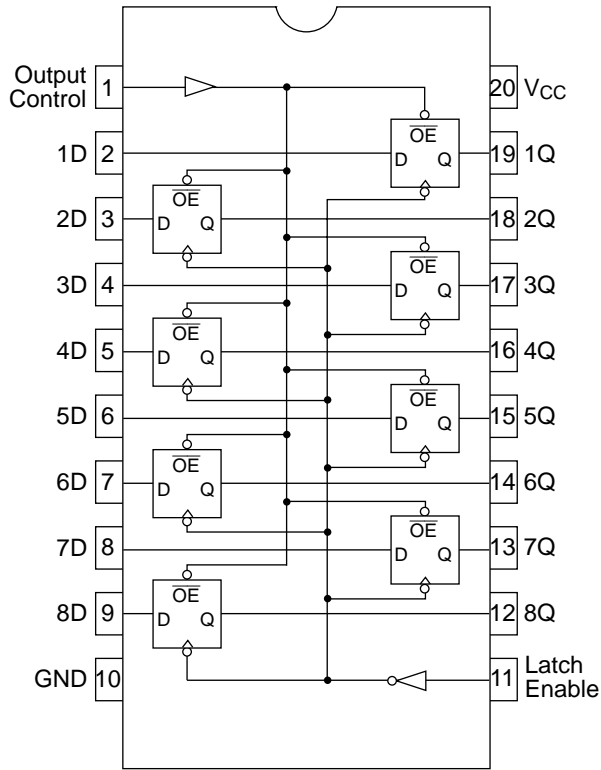
Pin Arrangement

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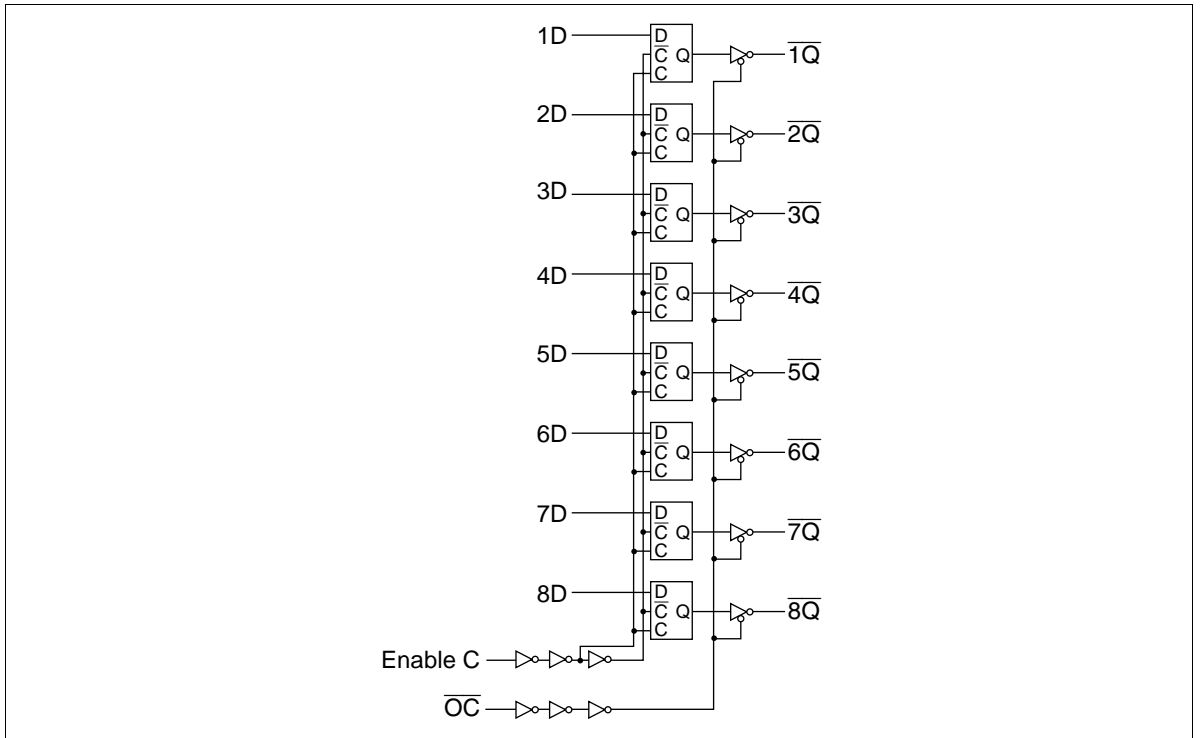


(Top view)

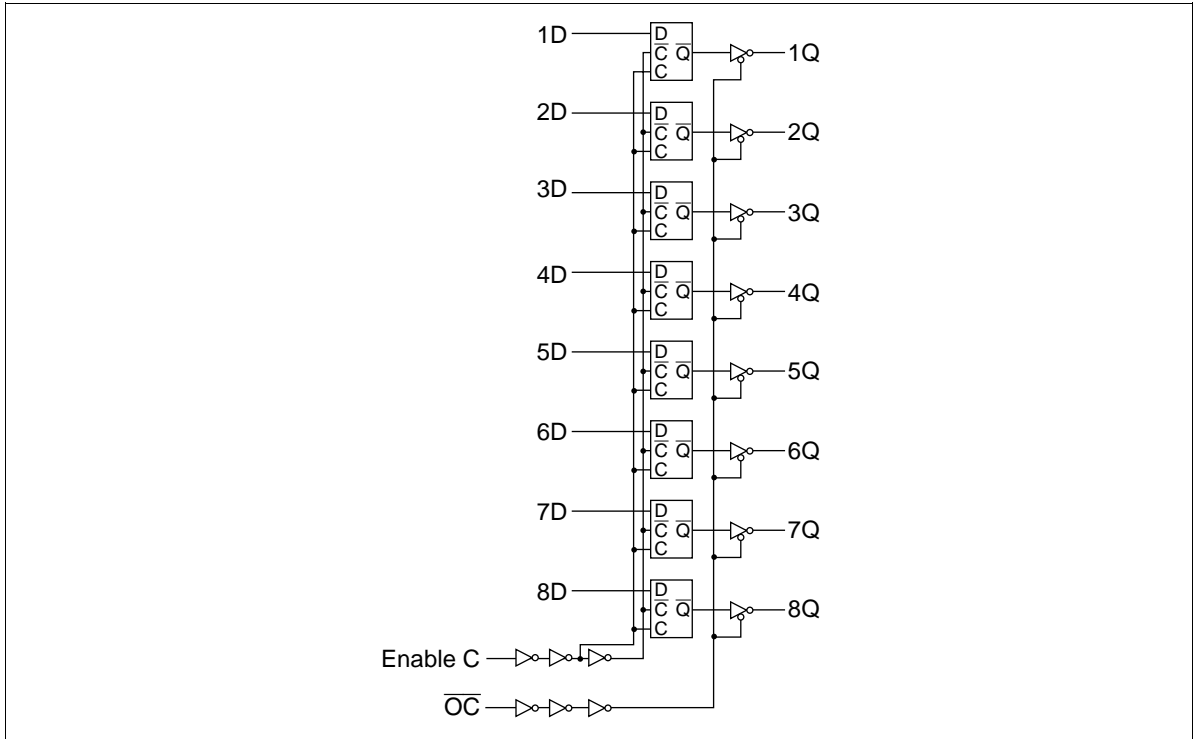
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Block Diagram

HD74HCT563



HD74HCT573



Absolute Maximum Ratings

| Item | Symbol | Rating | Unit |
|-------------------------------------|----------------------|------------------------|-------------|
| Supply voltage range | V_{CC} | -0.5 to +7.0 | V |
| Input voltage | V_{IN} | -0.5 to $V_{CC} + 0.5$ | V |
| Output voltage | V_{OUT} | -0.5 to $V_{CC} + 0.5$ | V |
| DC current drain per pin | I_{OUT} | ± 35 | mA |
| DC current drain per V_{CC} , GND | I_{CC} , I_{GND} | ± 75 | mA |
| DC input diode current | I_{IK} | ± 20 | mA |
| DC output diode current | I_{OK} | ± 20 | mA |
| Power dissipation per package | P_T | 500 | mW |
| Storage temperature | Tstg | -65 to +150 | $^{\circ}C$ |

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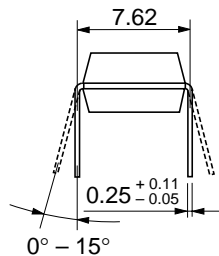
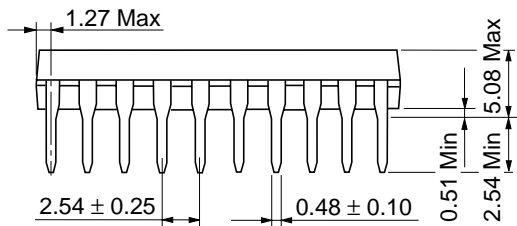
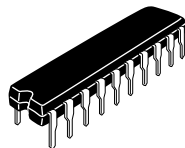
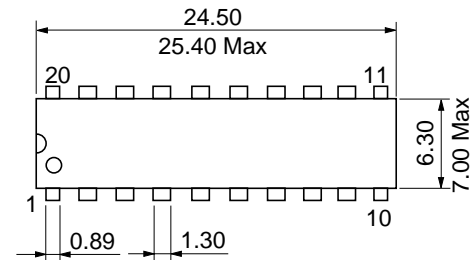
DC Characteristics

| Item | Symbol | Ta = 25°C | | Ta = -40 to +85°C | | Unit | Test Conditions | | |
|--------------------------|-----------------|-----------|-----|-------------------|------|------|-----------------|---------------------|---|
| | | Min | Typ | Max | Min | | Max | V _{CC} (V) | |
| Input voltage | V _{IH} | 2.0 | — | — | 2.0 | — | V | 4.5 to 5.5 | |
| | V _{IL} | — | — | 0.8 | — | 0.8 | V | 4.5 to 5.5 | |
| Output voltage | V _{OH} | 4.4 | — | — | 4.4 | — | V | 4.5 | Vin = V _{IH} or V _{IL} I _{OH} = -20 μA |
| | | 4.18 | — | — | 4.13 | — | | 4.5 | I _{OH} = -6 mA |
| | V _{OL} | — | — | 0.1 | — | 0.1 | V | 4.5 | Vin = V _{IH} or V _{IL} I _{OL} = 20 μA |
| | | — | — | 0.26 | — | 0.33 | | 4.5 | I _{OL} = 6 mA |
| Off-state output current | I _{OZ} | — | — | ±0.5 | — | ±5.0 | μA | 5.5 | Vin = V _{IH} or V _{IL} , Vout = V _{CC} or GND |
| Input current | I _{in} | — | — | ±0.1 | — | ±1.0 | μA | 5.5 | Vin = V _{CC} or GND |
| Quiescent current | I _{CC} | — | — | 4.0 | — | 40 | μA | 5.5 | Vin = V _{CC} or GND, Iout = 0 μA |

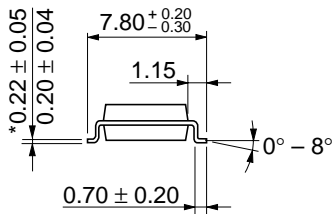
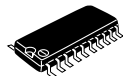
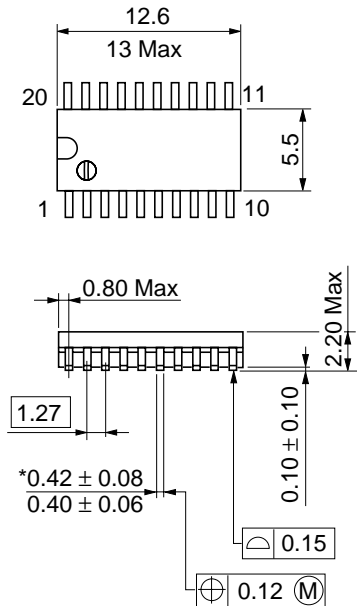
AC Characteristics (C_L = 50 pF, Input t_r = t_f = 6 ns)

| Item | Symbol | Ta = 25°C | | Ta = -40 to +85°C | | Unit | Test Conditions | | |
|------------------------|------------------|-----------|-----|-------------------|-----|------|-----------------|---------------------|--------------------------|
| | | Min | Typ | Max | Min | | Max | V _{CC} (V) | |
| Propagation delay time | t _{PLH} | — | 13 | 22 | — | 28 | ns | 4.5 | Data to Q, \bar{Q} |
| | t _{PHL} | — | 13 | 22 | — | 28 | | 4.5 | |
| | t _{PLH} | — | 14 | 23 | — | 29 | ns | 4.5 | Enable G to Q, \bar{Q} |
| | t _{PHL} | — | 14 | 23 | — | 29 | | 4.5 | |
| Output enable time | t _{ZL} | — | 14 | 30 | — | 38 | ns | 4.5 | |
| | t _{ZH} | — | 15 | 30 | — | 38 | | 4.5 | |
| Output disable time | t _{LZ} | — | 16 | 30 | — | 38 | ns | 4.5 | |
| | t _{HZ} | — | 17 | 30 | — | 38 | | 4.5 | |
| Setup time | t _{su} | 12 | 3 | — | 15 | — | ns | 4.5 | |
| Hold time | t _h | 5 | -1 | — | 5 | — | ns | 4.5 | |
| Pulse width | t _w | 16 | 4 | — | 20 | — | ns | 4.5 | |
| Output rise/fall time | t _{TLH} | — | 4 | 12 | — | 15 | ns | 4.5 | |
| | t _{THL} | — | 4 | 12 | — | 15 | | 4.5 | |
| Input capacitance | C _{in} | — | 5 | 10 | — | 10 | pF | — | |

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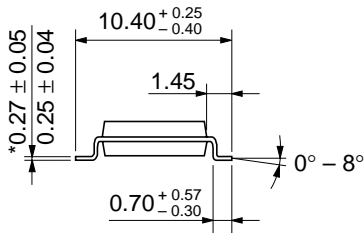
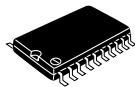
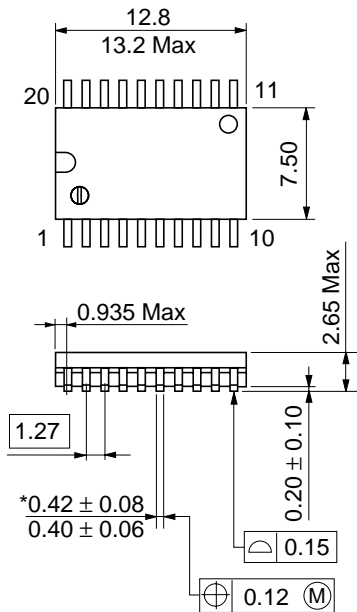


| | |
|--------------------------|----------|
| Hitachi Code | DP-20N |
| JEDEC | — |
| EIAJ | Conforms |
| Weight (reference value) | 1.26 g |



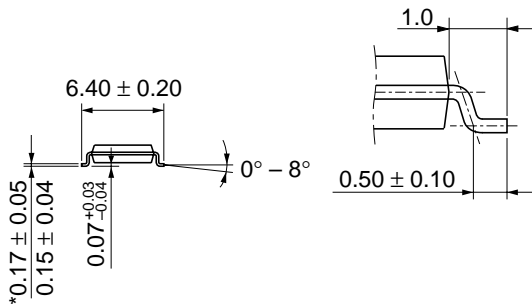
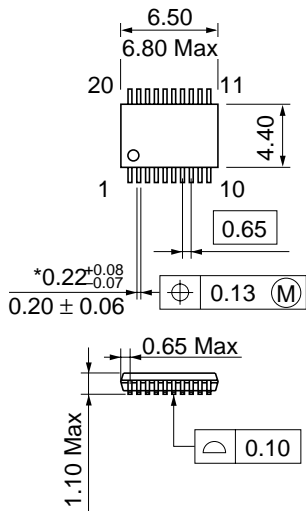
| | |
|--------------------------|----------|
| Hitachi Code | FP-20DA |
| JEDEC | — |
| EIAJ | Conforms |
| Weight (reference value) | 0.31 g |

*Dimension including the plating thickness
Base material dimension



| | |
|--------------------------|----------|
| Hitachi Code | FP-20DB |
| JEDEC | Conforms |
| EIAJ | — |
| Weight (reference value) | 0.52 g |

*Dimension including the plating thickness
 Base material dimension



*Dimension including the plating thickness
Base material dimension

| | |
|--------------------------|----------|
| Hitachi Code | TTP-20DA |
| JEDEC | — |
| EIAJ | — |
| Weight (reference value) | 0.07 g |

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL North America : <http://semiconductor.hitachi.com/>
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building, No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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